ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	© Co	pyright 2005. IPC, Bannoc International and Pan-Amer	kburn, Illinoi	s. All rights reser	tion with lowe	er level	parts, the	declaratio	on encomp	asses all lov	ver level mater	rials for wh	e: if the item is an as hich the manufactu • this declaration.				
1752-2 1.1		Web Site for Informa ://www.ipc.org/IPC-	C-1752 Standa	ard		orm Type * Declaration Class * stribute Class 6 - RoHS Yes/No, Homogeneous Materials							format				
Supplier Information																	
Company Name *		Company Unique ID		Unique ID A	uthority	Resp	onse Date	ə *	R	esponse Doo	cument ID						
RAMI TECHNOLOGY US	SA L					2022	-09-03										
Contact Name *		Phone - Co	ntact *	Ema	il - Contac	:t *			0 1 1 1	A (1 -							
YG Jiao QA manager				0755-21537	133	yg.jia	ao@raltro	n.com		Duplicat	e Contact ->	Contact -> Authorized Representative					
Authorized Representat	tive *	Title - Representativ	е	Phone - Re	presentative *	Ema	il - Repres	entative	e* Si	upplier Com	omments or URL for Additional Information						
John.lvens		QA manager		305-593-603	33	john	.ivens@ra	ltron.co	m								
Requester Item Number	er	Mfr Item Number		Mfr Item Nam	e	Effect	ive Date	Version	Manufact	uring Site	Weight *	UOM	Unit Type				
		RSE Product Family		RSE-H14 Pr	oduct Family	2022	-09-03				27.355	mg	Each				
Alternate Recommend	dation							Alternate	e Item Com	•							
Manufacturing Proce	ess In	formation						•									
Terminal Plating / Grid Array	/ Mater	rial	Terminal E	Base Alloy	J-STD-020 MSL I	Rating	Peak Proc	ess Body	/ Temperat	ure Max Time	e at Peak Temp	erature Nu	Imber of Reflow Cyc	es			
Matte Tin (Sn) Ko			Kovar		1				245 C		10 sec	conds 2					
Comments			!				1			I		I					

Save the fields in this form to a fileExport DataImport fields from a file into this formClear all of the fields on this formImport DataImport DataReset Form	Lock the fields on this form to prevent changes	Lock Supplier Fields										
RoHS Material Composition Declaration Declaration Type * Detailed												
RoHS Directive 2002/95/ECRoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium												
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2002/95/EC and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.												
RoHS Declaration * 3 - Item(s) does not contain RoHS restricted substances per the definition above except for lead in solders and selected exemptions, if any	Supplier Acceptance * Accept	oted										
Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then above and choose all applicable exemptions.	select the corresponding respon	se in the RoHS Declaration										
Exemption List Version EL-2006/690/EC												
+ - 7a. Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).												
Declaration Signature												
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-or the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.	down. This will display the sig	nature area. Digitally sign										

Supplier Digital Signature YG Jiao	教学版化容: YG Jaco DN: cnrvYG Jaco, cnrAMI TECHNOLOGY USA LLC, ou=QA, emailinygiao@gramitechnology.com, enCN 日間, 2013 08.27 09.4680.6 96000	
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Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	ltem/Subitem Name		Homogeneous Material	Weight	Unit of Measure		Level	Substance Category			Substance	CAS	Exempt	Weight	Unit of Measure	Tolera	ance +	PPM
+1 -1	RSE-H14	+M -M	Base	4.774	mg	+C -C	Supplier	Metal Ring	+S	-S	Fe	7439-89-6		0.807	mg			
									+S	-S	Co	7440-48-4		0.007	mg			
									+S	-S	Mn	7439-96-5		0.006	mg			
									+S	-S	Si	7440-21-3		0.002	mg			
									+S	-S	с	7440-44-0		0.001	mg			
						+C -C	Supplier	Glass	+S	-S	SiO2	14808-60-7		0.308	mg			
									+S	-S	AI2O3	1344-28-1		0.044	mg			
									+S	-s	B2O3	1303-86-2		0.081	mg			
									+S	-S	Li2O	12057-24-8		0.011	mg			
										-S		1313-59-3		0.044	mg			
					1	_				-S		12136-45		0.011	mg			
						+C -C	Supplier	LEADS		-S		7439-89-6		1.196	mg			
										-S		7440-48-4		0.379	mg			
											Si	7440-21-3		0.006	mg			
											Mn	7439-96-5		0.002	mg			
						+C -C	Supplier	Surface coating			Cu	7440-50-8		0.044	mg			
						_		Ι		<u> </u>	Sn	7440-31-5		0.079	mg			ļ
						+C -C		Lead/Lead Compound					7c. Lead	0.527	mg			
				1		+C -C		Nickel (external applic				7440-02-0		1.219	mg			Ĺ
		+M -M	Cover	8.277	mg	+C -C	Supplier	Metal Case			Cu	7440-50-8		5.078	mg			
											Fe	7439-89-6		0.003	mg			
					I			[Zn	1314-13-2			mg			┥
						+C -C	В	Nickel (external applic	+S	-S	Nickel	7440-02-0		1.7	mg			

+M -M Quartz Crystal	0.972	mg	+C -C Supp	olier (Quartz	+S	-S	SiO2	14808-60-7		0.346	mg	
			+C -C Supp	plier E	Blank Mtalization	+S	-S	Cr	7440-47-3		0.0006	mg	
						+S	-S	Ag	7440-22-4		0.0004	mg	
			+C -C Supp	plier	Solder	+S	-S	Ag	7440-22-4		0.028	mg	
						+S	-S	Sn	7440-31-5		0.063	mg	
			+C -C A	L	ead/Lead Compound	+S	-S	Lead	7439-92-1	7a. Lead	0.534	mg	
+M -M Plastic mold	9.967	mg	+C -C Supp	olier E	Epoxy compound	+S	-S	C7H8O3S C4H9NO	13732-62-2		0.535	mg	
						+S	-S	Epoxy Resin	85954-11-6		1.237	mg	
						+S	-S	Amorphous silica	T112945-		7.245	mg	
						+S	-S	Zinc Borate	1332-07-6		0.531	mg	
						+S	-S	Carbon Black	01333-86-4		0.227	mg	
						+S	-S	C9H20O5Si	2530-83-8		0.192	mg	
+M -M Lead Frame	3.365	mg	+C -C Supp	olier I	Metal Frame	+S	-S	Cu	7440-50-8		2.892	mg	
			_			+S	-S	Zn	1314-13-2		0.424	mg	
			+C -C Supp	plier	Surface coating	+S	-S	Sn	7440-31-5		0.048	mg	
						+S	-S	Cu	7440-50-8		0.001	mg	